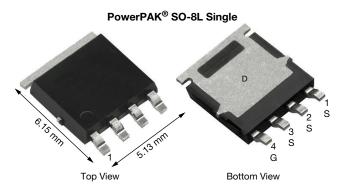
## SQJA76EP

www.vishay.com

**Vishay Siliconix** 

# Automotive N-Channel 40 V (D-S) 175 °C MOSFET



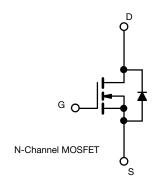
PRODUCT SUMMARY	
V <sub>DS</sub> (V)	40
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.0024
I <sub>D</sub> (A)	75
Configuration	Single

### FEATURES

- TrenchFET<sup>®</sup> power MOSFET
- AEC-Q101 qualified
- 100 % R<sub>q</sub> and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



COMPLIANT HALOGEN



ORDERING INFORMATION	
Package	PowerPAK SO-8L
Lead (Pb)-free and halogen-free	SQJA76EP (for detailed order number please see <u>www.vishay.com/doc?79771</u> )

ABSOLUTE MAXIMUM RATINGS (To	<sub>C</sub> = 25 °C, unles	s otherwise noted	)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	40	V	
Gate-source voltage		V <sub>GS</sub>	± 20	v	
Continuous drain current	T <sub>C</sub> = 25 °C ª	1-	75		
Continuous drain current	T <sub>C</sub> = 125 °C	Ι <sub>D</sub>	65.6		
Continuous source current (diode conduction)		I <sub>S</sub>	62	А	
Pulsed drain current <sup>b</sup>		I <sub>DM</sub>	200		
Single pulse avalanche current	L = 0.1 mH	I <sub>AS</sub>	44		
Single pulse avalanche energy		E <sub>AS</sub>	96.8	mJ	
Maximum power dissipation <sup>b</sup>	T <sub>C</sub> = 25 °C	Р	68	W	
Maximum power dissipation -	T <sub>C</sub> = 125 °C	P <sub>D</sub>	22	vv	
Operating junction and storage temperature range	)	T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	
Soldering recommendations (peak temperature) d, e			260	C	

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-ambient	PCB mount <sup>c</sup>	R <sub>thJA</sub>	68	°C/W
Junction-to-case (drain)		R <sub>thJC</sub>	2.2	0/10

#### Notes

a. Package limited

b. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %

c. When mounted on 1" square PCB (FR4 material)

d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

S22-0380-Rev. B, 02-May-2022

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		•		•			
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0, I_D = 250 \ \mu A$		40	-	-	V
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	- V <sub>GS</sub> , I <sub>D</sub> = 250 μΑ	2.5	3.0	3.5	v
Gate-source leakage	I <sub>GSS</sub>	V <sub>DS</sub> =	$0 V, V_{GS} = \pm 20 V$	-	-	± 100	nA
		$V_{GS} = 0 V$	V <sub>DS</sub> = 40 V	-	-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = 40 V, T <sub>J</sub> = 125 °C	-	-	50	μA
		$V_{GS} = 0 V$	V <sub>DS</sub> = 40 V, T <sub>J</sub> = 175 °C	-	-	200	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>GS</sub> = 10 V	$V_{DS} \ge 5 V$	30	-	-	А
		$V_{GS} = 10 V$	I <sub>D</sub> = 10 A	-	0.0020	0.0024	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 10 A, T <sub>J</sub> = 125 °C	-	-	0.0040	Ω
		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 10 A, T <sub>J</sub> = 175 °C	-	-	0.0050	
Forward transconductance b	9 <sub>fs</sub>	V <sub>DS</sub>	-	48	-	S	
Dynamic <sup>b</sup>		•		•			
Input capacitance	C <sub>iss</sub>		V <sub>DS</sub> = 25 V, f = 1 MHz	-	4005	5250	pF
Output capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$		-	1160	1550	
Reverse transfer capacitance	C <sub>rss</sub>			-	90	120	
Total gate charge <sup>c</sup>	Qg			-	66	100	
Gate-source charge <sup>c</sup>	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$V_{DS} = 20 \text{ V}, I_{D} = 10 \text{ A}$	-	17	-	nC
Gate-drain charge <sup>c</sup>	Q <sub>gd</sub>			-	14	-	
Gate resistance	R <sub>g</sub>	f = 1 MHz		0.35	0.76	1.2	Ω
Turn-on delay time <sup>c</sup>	t <sub>d(on)</sub>			-	17	30	
Rise time <sup>c</sup>	tr	V <sub>DD</sub>	$V_{DD} = 20 \text{ V}, \text{ R}_{\text{I}} = 2 \Omega$		17	30	- ns
Turn-off delay time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong 10 \text{ Å}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		-	32	50	
Fall time <sup>c</sup>	t <sub>f</sub>			-	8	15	
Source-Drain Diode Ratings and Char	acteristics <sup>b</sup>						
Pulsed current <sup>a</sup>	I <sub>SM</sub>			-	-	200	А
Forward voltage	V <sub>SD</sub>	$I_F = 10 \text{ A}, V_{GS} = 0 \text{ V}$		-	0.76	1.2	V
Body diode reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> = 10 A, di/dt = 100 A/μs		-	65	130	ns
Body diode reverse recovery charge	Q <sub>rr</sub>			-	123	250	nC
Reverse recovery fall time	t <sub>a</sub>			-	35	-	ns
Reverse recovery rise time	t <sub>b</sub>			-	30	-	ns
Body diode peak reverse recovery current	I <sub>RM(REC)</sub>			-	-3.3	-	А

### Notes

a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$ 

b. Guaranteed by design, not subject to production testing

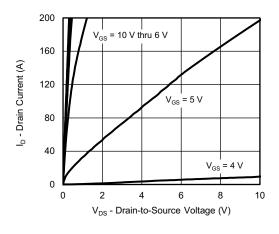
c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

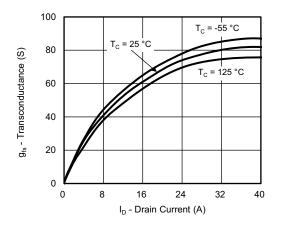
2 For technical questions, contact: <u>automostechsupport@vishav.com</u>



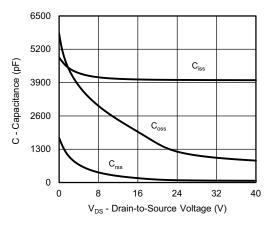
## **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



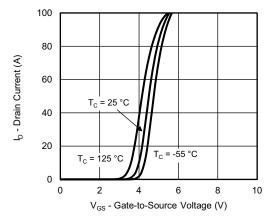
**Output Characteristics** 



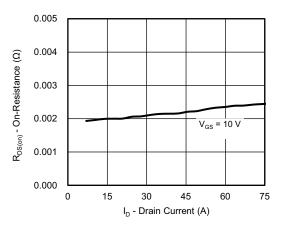
Transconductance



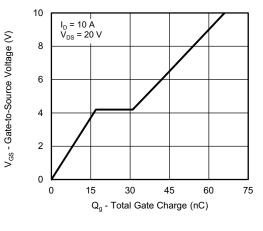
#### Capacitance



**Transfer Characteristics** 



**On-Resistance vs. Drain Current** 



Gate Charge

S22-0380-Rev. B, 02-May-2022

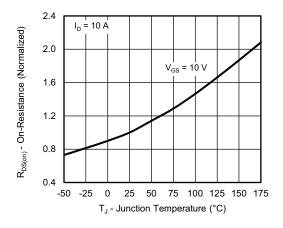
3

Document Number: 77398

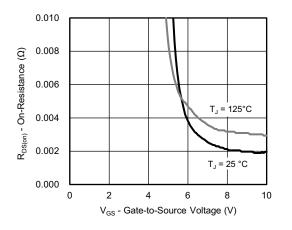
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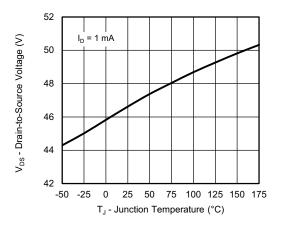
## TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C, unless otherwise noted)



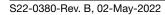
**On-Resistance vs. Junction Temperature** 



**On-Resistance vs. Gate-to Source Voltage** 



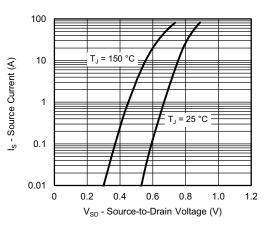
Drain Source Breakdown vs. Junction Temperature



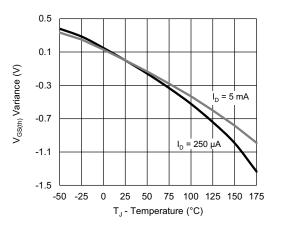
4

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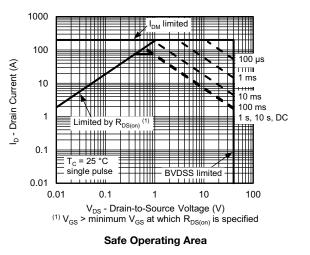
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Source Drain Diode Forward Voltage



**Threshold Voltage** 

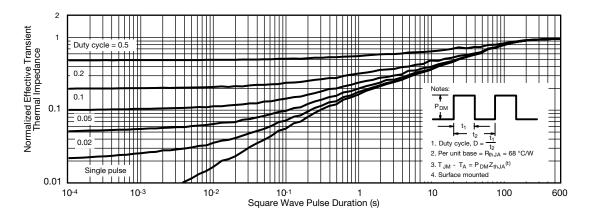




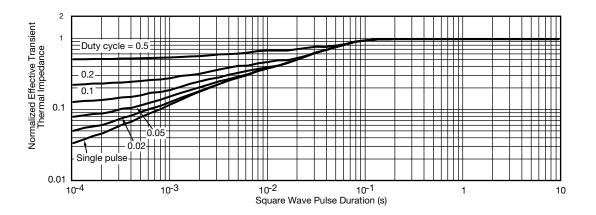
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## TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



#### Normalized Thermal Transient Impedance, Junction-to-Case

### Note

- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
  - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

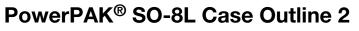
are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

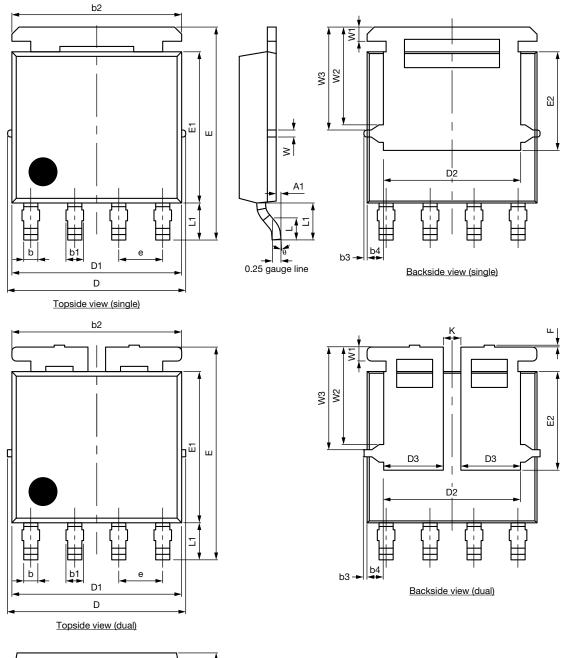
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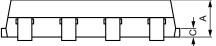
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1 For technical questions, contact: pmostechsupport@vishay.com

# **Package Information**



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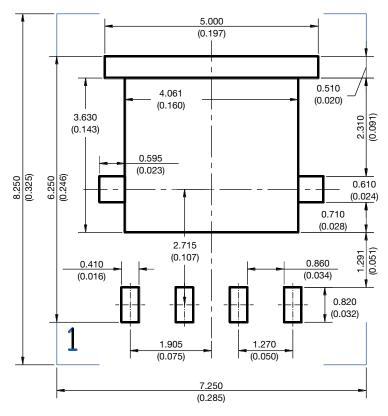
DIM.		MILLIMETERS			INCHES			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
А	1.00	1.07	1.14	0.039	0.042	0.045		
A1	0.00	-	0.127	0.00	-	0.005		
b	0.33	0.41	0.48	0.013	0.016	0.019		
b1	0.44	0.51	0.58	0.017	0.020	0.023		
b2	4.80	4.90	5.00	0.189	0.193	0.197		
b3		0.094	•		0.004			
b4		0.47			0.019			
С	0.20	0.25	0.30	0.008	0.010	0.012		
D	5.00	5.13	5.25	0.197	0.202	0.207		
D1	4.80	4.90	5.00	0.189	0.193	0.197		
D2	3.86	3.96	4.06	0.152	0.156	0.160		
D3	1.63	1.73	1.83	0.064	0.068	0.072		
е		1.27 BSC	•	0.050 BSC				
E	6.05	6.15	6.25	0.238	0.242	0.246		
E1	4.27	4.37	4.47	0.168	0.172	0.176		
E2	2.75	2.85	2.95	0.108	0.112	0.116		
F	-	-	0.15	-	-	0.006		
L	0.62	0.72	0.82	0.024	0.028	0.032		
L1	0.92	1.07	1.22	0.036	0.042	0.048		
К		0.51			0.020			
W		0.23			0.009			
W1		0.41			0.016			
W2		2.82			0.111			
W3		2.96		0.117				
θ	0°	-	10°	0°	-	10°		

Note

• Millimeters will govern



### RECOMMENDED MINIMUM PAD FOR PowerPAK<sup>®</sup> SO-8L SINGLE



Recommended Minimum Pads Dimensions in mm (inches)

Revision: 07-Feb-12

1



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